查询SN74S299N3供应商

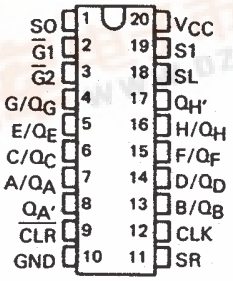
SN54LS299, SN54S299, SN74LS299, SN74S299
8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS

SDLS156 – MARCH 1974 – REVISED MARCH 1988

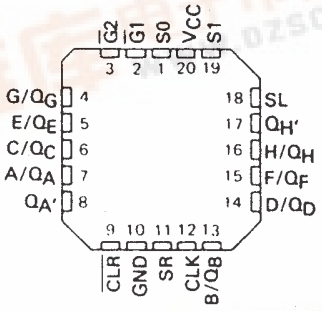
- **Multiplexed Inputs/Outputs Provide Improved Bit Density**
- **Four Modes of Operations:**
  Hold (Store) Shift Left
  Shift Right Load Data
- **Operates with Outputs Enabled or at High Z**
- **3-State Outputs Drive Bus Lines Directly**
- **Can Be Cascaded for N-Bit Word Lengths**
- **SN54LS323 and SN74LS323 Are Similar But Have Synchronous Clear**
- **Applications:**
  Stacked or Push-Down Registers
  Buffer Storage, and Accumulator Registers

TYPE	GUARANTEED SHIFT (CLOCK) FREQUENCY	TYPICAL POWER DISSIPATION
'LS299	25 MHz	175 mW
'S299	50 MHz	700 mW

SN54LS299, SN54S299 . . . J OR W PACKAGE
SN74LS299, SN74S299 . . . DW OR N PACKAGE
(TOP VIEW)



SN54LS299, SN54S299 . . . FK PACKAGE
(TOP VIEW)



description

These Schottky TTL eight-bit universal registers feature multiplexed inputs/outputs to achieve full eight-bit data handling in a single 20-pin package. Two function-select inputs and two output-control inputs can be used to choose the modes of operation listed in the function table.

Synchronous parallel loading is accomplished by taking both function-select lines, S0 and S1, high. This places the three-state outputs in a high-impedance state, which permits data that is applied on the input/output lines to be clocked into the register. Reading out of the register can be accomplished while the outputs are enabled in any mode. A direct overriding input is provided to clear the register whether the outputs are enabled or off.

FUNCTION TABLE

MODE	INPUTS								INPUTS/OUTPUTS								OUTPUTS	
	$\overline{CLR}$	FUNCTION SELECT		OUTPUT CONTROL		CLK	SERIAL		A/Q_A	B/Q_B	C/Q_C	D/Q_D	E/Q_E	F/Q_F	G/Q_G	H/Q_H	$Q_{A'}$	$Q_{H'}$
		S1	S0	$\overline{G1}$†	$\overline{G2}$†		SL	SR										
Clear	L	X	L	L	L	X	X	X	L	L	L	L	L	L	L	L	L	L
	L	L	X	L	L	X	X	X	L	L	L	L	L	L	L	L	L	L
	L	H	H	X	X	X	X	X	X	X	X	X	X	X	X	X	L	L
Hold	H	L	L	L	L	X	X	X	Q_{A0}	Q_{B0}	Q_{C0}	Q_{D0}	Q_{E0}	Q_{F0}	Q_{G0}	Q_{H0}	Q_{A0}	Q_{H0}
	H	X	X	L	L	L	X	X	Q_{A0}	Q_{B0}	Q_{C0}	Q_{D0}	Q_{E0}	Q_{F0}	Q_{G0}	Q_{H0}	Q_{A0}	Q_{H0}
Shift Right	H	L	H	L	L	↑	X	H	H	Q_{An}	Q_{Bn}	Q_{Cn}	Q_{Dn}	Q_{En}	Q_{Fn}	Q_{Gn}	H	Q_{Gn}
	H	L	H	L	L	↑	X	L	L	Q_{An}	Q_{Bn}	Q_{Cn}	Q_{Dn}	Q_{En}	Q_{Fn}	Q_{Gn}	L	Q_{Gn}
Shift Left	H	H	L	L	L	↑	H	X	Q_{Bn}	Q_{Cn}	Q_{Dn}	Q_{En}	Q_{Fn}	Q_{Gn}	Q_{Hn}	H	Q_{Bn}	H
	H	H	L	L	L	↑	L	X	Q_{Bn}	Q_{Cn}	Q_{Dn}	Q_{En}	Q_{Fn}	Q_{Gn}	Q_{Hn}	L	Q_{Bn}	L
Load	H	H	H	X	X	↑	X	X	a	b	c	d	e	f	g	h	a	h

†When one or both output controls are high the eight input/output terminals are disabled to the high-impedance state; however, sequential operation or clearing of the register is not affected.

a . . . h = the level of the steady-state input at inputs A through H, respectively. These data are loaded into the flip-flops while the flip-flop outputs are isolated from the input/output terminals.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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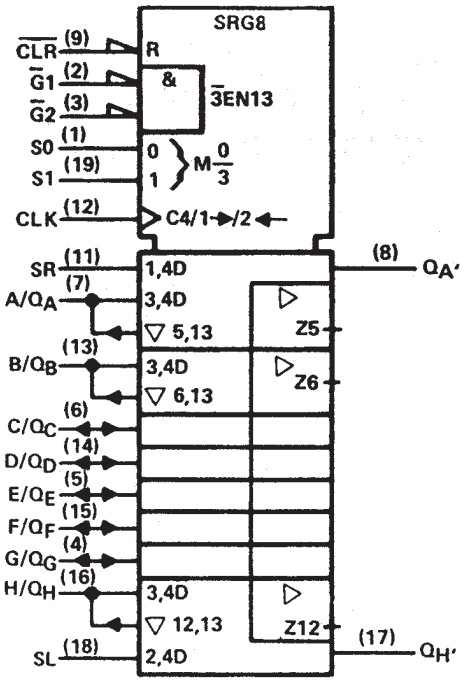
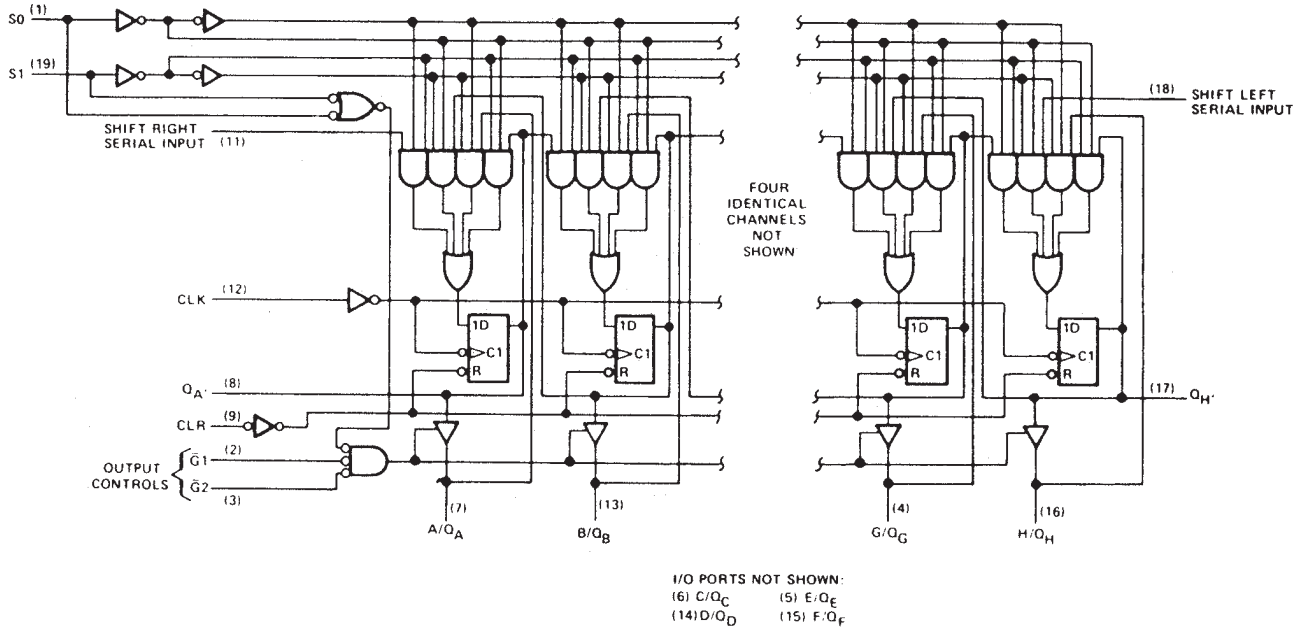
TEXAS INSTRUMENTS

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for DW, J, N, and W packages.

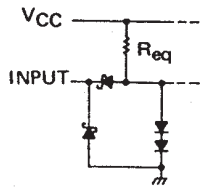
logic diagram (positive logic)



Pin numbers shown are for DW, J, N, and W packages.

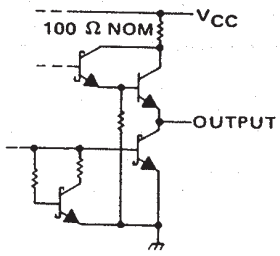
schematics of inputs and outputs

EQUIVALENT OF EACH INPUT

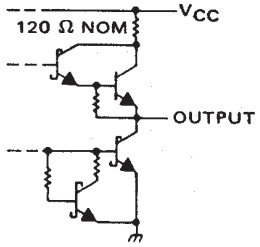


S0, S1: R_{eq} = 9 kΩ NOM
All other inputs: R_{eq} = 18 kΩ NOM

TYPICAL OF OUTPUTS Q_A THRU Q_H



TYPICAL OF OUTPUTS $Q_{A'}$ THRU $Q_{H'}$



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage . . . . . 7 V
Off-state output voltage . . . . . 5.5 V
Operating free-air temperature range: SN54LS299 . . . . . −55°C to 125°C
SN74LS299 . . . . . 0°C to 70°C
Storage temperature . . . . . −65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54LS299			SN74LS299			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}	Q_A thru Q_H			−1			−2.6	mA
	$Q_{A'}$ or $Q_{H'}$			−0.4			−0.4	
Low-level output current, I_{OL}	Q_A thru Q_H			12			24	mA
	$Q_{A'}$ or $Q_{H'}$			4			8	
Clock frequency, f_{clock}		0		20	0		20	MHz
Width of clock pulse, $t_{w(clock)}$	Clock high	30			30			ns
	Clock low	18			10			
Width of clear pulse, $t_{w(clear)}$	$\overline{\text{Clear}}$ low	25			20			ns
Setup time, t_{su}	Select	35†			35†			ns
	High-level data†	20†			20†			
	Low-level data†	20†			20†			
	$\overline{\text{Clear}}$ inactive-state	24†			20†			
Hold time, t_h	Select	10†			10†			ns
	Data†	3†			0†			
Operating free-air temperature, T_A		−55		125	0		70	°C

† Data includes the two serial inputs and the eight input/output data lines.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†		SN54LS299			SN74LS299			UNIT
					MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IH}	High-level input voltage				2			2			V
V_{IL}	Low-level input voltage						0.7			0.8	V
V_{IK}	Input clamp voltage		V_{CC} = MIN,	I_I = −18 mA			−1.5			−1.5	V
V_{OH}	High-level output voltage	Q_A thru Q_H	V_{CC} = MIN,	V_{IH} = 2 V,	2.4	3.2		2.4	3.1		V
		Q_A' or Q_H'	V_{IL} = V_{IL}max,	I_{OH} = MAX	2.5	3.4		2.7	3.4		
V_{OL}	Low-level output voltage	Q_A thru Q_H	V_{CC} = MIN,	I_{OL} = 12 mA		0.25	0.4		0.25	0.4	V
			V_{IH} = 2 V,	I_{OL} = 24 mA					0.35	0.5	
		Q_A' or Q_H'	V_{IL} = V_{IL}max	I_{OL} = 4 mA		0.25	0.4		0.25	0.4	
				I_{OL} = 8 mA					0.35	0.5	
I_{OZH}	Off-state output current, high-level voltage applied	Q_A thru Q_H	V_{CC} = MAX, V_O = 2.7 V	V_{IH} = 2 V,			40			40	μA
I_{OZL}	Off-state output current, low-level voltage applied	Q_A thru Q_H	V_{CC} = MAX, V_O = 0.4 V	V_{IH} = 2 V,			−400			−400	μA
I_I	Input current at maximum input voltage	S0, S1	V_{CC} = MAX	V_I = 7 V			200			200	μA
		A thru H		V_I = 5.5 V			100			100	
		Any other		V_I = 7 V			100			100	
I_{IH}	High-level input current	A thru H, S0, S1	V_{CC} = MAX,	V_I = 2.7 V			40			40	μA
		Any other					20			20	
I_{IL}	Low-level input current	S0, S1	V_{CC} = MAX,	V_I = 0.4 V			−0.8			−0.8	mA
		Any other					−0.4			−0.4	
I_{OS}	Short-circuit output current§	Q_A thru Q_H	V_{CC} = MAX		−30		−130	−30		−130	mA
		Q_A' or Q_H'			−20		−100	−20		−100	
I_{CC}	Supply current		V_{CC} = MAX			33	53		33	53	mA

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡All typical values are at V_{CC} = 5 V, T_A = 25°C.
§Not more than one output should be shorted at a time and duration of the short-circuit should not exceed one second.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

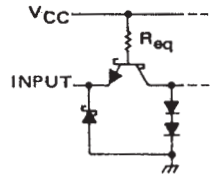
PARAMETER¶	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f_{max}			See Note 2	20	35		MHz
t_{PLH}	CLK	Q_A' or Q_H'	R_L = 2 kΩ, C_L = 15 pF		22	33	ns
t_{PHL}					26	39	
t_{PHL}	$\overline{CLR}$	Q_A' or Q_H'			27	40	ns
t_{PLH}	CLK	Q_A thru Q_H	R_L = 665 Ω, C_L = 45 pF		17	25	ns
t_{PHL}					26	39	
t_{PHL}	$\overline{CLR}$	Q_A thru Q_H			26	40	ns
t_{PZH}	$\overline{G}1$, $\overline{G}2$	Q_A thru Q_H			13	21	ns
t_{PZL}					19	30	
t_{PHZ}	$\overline{G}1$, $\overline{G}2$	Q_A thru Q_H	R_L = 665 Ω, C_L = 5 pF		10	20	ns
t_{PLZ}					10	15	

¶f_{max} ≡ maximum clock frequency
t_{PLH} ≡ propagation delay time, low-to-high-level output
t_{PHL} ≡ propagation delay time, high-to-low-level output
t_{PZH} ≡ output enable time to high level
t_{PZL} ≡ output enable time to low level
t_{PHZ} ≡ output disable time from high level
t_{PLZ} ≡ output disable time from low level

NOTE 2: For testing f_{max}, all outputs are loaded simultaneously, each with C_L and R_L as specified for the propagation times. Load circuits and voltage waveforms are shown in Section 1.

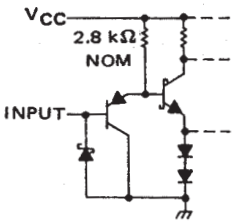
schematics of inputs and outputs

EQUIVALENT OF CLOCK AND CLEAR INPUTS

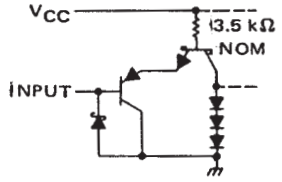


Clock: R_{eq} = 2.8 kΩ NOM
Clear: R_{eq} = 3.5 kΩ NOM

EQUIVALENT OF $\overline{G1}$ AND $\overline{G2}$ INPUTS

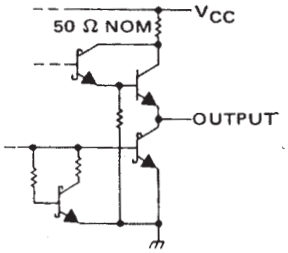


EQUIVALENT OF A THRU H†, S0, S1, SHIFT RIGHT, AND SHIFT LEFT INPUTS

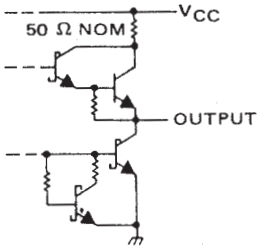


†When 3-state outputs are disabled.

TYPICAL OF OUTPUTS Q_A THRU Q_H



TYPICAL OF OUTPUTS $Q_{A'}$ AND $Q_{H'}$



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage . . . . . 5.5 V
Off-state output voltage . . . . . 5.5 V
Operating free-air temperature range: SN54S299 (See Note 1) . . . . . −55°C to 125°C
SN74S299 . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54S299			SN74S299			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}	Q_A thru Q_H			−2			−6.5	mA
	$Q_{A'}$ or $Q_{H'}$			−0.5			−0.5	
Low-level output current, I_{OL}	Q_A thru Q_H			20			20	mA
	$Q_{A'}$ or $Q_{H'}$			6			6	
Clock frequency, f_{clock}		0		50	0		50	MHz
Width of clock pulse, $t_{w(clock)}$	Clock high	10			10			ns
	Clock low	10			10			
Width of clear pulse, $t_{w(clear)}$	$\overline{\text{Clear}}$ low	10			10			ns
Setup time, t_{su}	Select	15↑			15↑			ns
	High-level data‡	7↑			7↑			
	Low-level data‡	5↑			5↑			
	$\overline{\text{Clear}}$ inactive-state	10↑			10↑			
Hold time, t_h	Select	5↑			5↑			ns
	Data‡	5↑			5↑			
Operating free-air temperature, T_A		−55		125	0		70	°C

‡ Data includes the two serial inputs and the eight input/output data lines.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†	MIN	TYP‡	MAX	UNIT
V_{IH}	High-level input voltage			2			V
V_{IL}	Low-level input voltage					0.8	V
V_{IK}	Input clamp voltage		V_{CC} = MIN, I_I = −18 mA			−1.2	V
V_{OH}	High-level output voltage	Q_A thru Q_H	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OH} = MAX	2.4	3.2		V
		Q_A' or Q_H'		2.7	3.4		
V_{OL}	Low-level output voltage		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OL} = MAX			0.5	V
I_{OZH}	Off-state output current, high-level voltage applied	Q_A thru Q_H	V_{CC} = MAX, V_{IH} = 2 V, V_O = 2.4 V			100	μA
I_{OZL}	Off-state output current, low-level voltage applied	Q_A thru Q_H	V_{CC} = MAX, V_{IH} = 2 V, V_O = 0.5 V			−250	μA
I_I	Input current at maximum input voltage		V_{CC} = MAX, V_I = 5.5 V			1	mA
I_{IH}	High-level input current	A thru H, S0, S1	V_{CC} = MAX, V_I = 2.7 V			100	μA
		Any other				50	
I_{IL}	Low-level input current	CLK or $\overline{CLR}$	V_{CC} = MAX, V_I = 0.5 V			−2	mA
		S0, S1				−500	μA
		Any other				−250	μA
I_{OS}	Short-circuit output current§	Q_A thru Q_H	V_{CC} = MAX	−40		−100	mA
		Q_A' or Q_H'		−20		−100	
I_{CC}	Supply current		V_{CC} = MAX		140	225	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time and duration of the short-circuit should not exceed one second.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER¶	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f_{max}			See Note 2	50	70		MHz
t_{PLH}	CLK	Q_A' or Q_H'	R_L = 1 kΩ, C_L = 15 pF		12	20	ns
t_{PHL}					13	20	
t_{PHL}	$\overline{CLR}$	Q_A' or Q_H'			14	21	ns
t_{PLH}	CLK	Q_A thru Q_H	R_L = 280 Ω, C_L = 45 pF		15	21	ns
t_{PHL}					15	21	
t_{PHL}	$\overline{CLR}$	Q_A thru Q_H			16	24	ns
t_{PZH}	$\overline{G}1$, $\overline{G}2$	Q_A thru Q_H			10	18	ns
t_{PZL}					12	18	
t_{PHZ}	$\overline{G}1$, $\overline{G}2$	Q_A thru Q_H	R_L = 280 Ω, C_L = 5 pF		7	12	ns
t_{PLZ}					7	12	

¶ f_{max} = maximum clock frequency
t_{PLH} = Propagation delay time, low-to-high-level output
t_{PHL} = Propagation delay time, high-to-low-level output
t_{PZH} = output enable time to high level
t_{PZL} = output enable time to low level
t_{PHZ} = output disable time from high level
t_{PLZ} = output disable time from low level
NOTE 2: For testing f_{max}, all outputs are loaded simultaneously, each with C_L and R_L as specified for the propagation times.
Load circuits and voltage waveforms are shown in Section 1.

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Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
Low Power Wireless	www.ti.com/lpw	Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

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DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
Low Power Wireless	www.ti.com/lpw	Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

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Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
Low Power Wireless	www.ti.com/lpw	Telephony	www.ti.com/telephony
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Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
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		Video & Imaging	www.ti.com/video
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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)
78024012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
7802401RA	ACTIVE	CDIP	J	20	1	TBD	A42 SNPB	N / A for Pkg Type
7802401RA	ACTIVE	CDIP	J	20	1	TBD	A42 SNPB	N / A for Pkg Type
7802401SA	ACTIVE	CFP	W	20	1	TBD	A42	N / A for Pkg Type
7802401SA	ACTIVE	CFP	W	20	1	TBD	A42	N / A for Pkg Type
SN54LS299J	ACTIVE	CDIP	J	20	1	TBD	A42 SNPB	N / A for Pkg Type
SN54LS299J	ACTIVE	CDIP	J	20	1	TBD	A42 SNPB	N / A for Pkg Type
SN54S299J	OBSOLETE	CDIP	J	20		TBD	Call TI	Call TI
SN54S299J	OBSOLETE	CDIP	J	20		TBD	Call TI	Call TI
SN74LS299DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS299DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS299DWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS299DWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS299DWG4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS299DWG4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS299DWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS299DWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS299DWRE4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS299DWRE4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS299DWRG4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS299DWRG4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS299N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS299N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS299NE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS299NE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74S299DW	OBSOLETE	SOIC	DW	20		TBD	Call TI	Call TI
SN74S299DW	OBSOLETE	SOIC	DW	20		TBD	Call TI	Call TI
SN74S299DWR	OBSOLETE	SOIC	DW	20		TBD	Call TI	Call TI
SN74S299DWR	OBSOLETE	SOIC	DW	20		TBD	Call TI	Call TI
SN74S299N	OBSOLETE	PDIP	N	20		TBD	Call TI	Call TI
SN74S299N	OBSOLETE	PDIP	N	20		TBD	Call TI	Call TI

Orderable Device	Status [1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan [2]	Lead/Ball Finish	MSL Peak Temp [3]
SN74S299N3	OBSOLETE	PDIP	N	20		TBD	Call TI	Call TI
SN74S299N3	OBSOLETE	PDIP	N	20		TBD	Call TI	Call TI
SNJ54LS299FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS299FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS299J	ACTIVE	CDIP	J	20	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS299J	ACTIVE	CDIP	J	20	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS299W	ACTIVE	CFP	W	20	1	TBD	A42	N / A for Pkg Type
SNJ54LS299W	ACTIVE	CFP	W	20	1	TBD	A42	N / A for Pkg Type
SNJ54S299FK	OBSOLETE	LCCC	FK	20		TBD	Call TI	Call TI
SNJ54S299FK	OBSOLETE	LCCC	FK	20		TBD	Call TI	Call TI
SNJ54S299J	OBSOLETE	CDIP	J	20		TBD	Call TI	Call TI
SNJ54S299J	OBSOLETE	CDIP	J	20		TBD	Call TI	Call TI
SNJ54S299W	OBSOLETE	CFP	W	20		TBD	Call TI	Call TI
SNJ54S299W	OBSOLETE	CFP	W	20		TBD	Call TI	Call TI

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ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

[2] Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

[3] MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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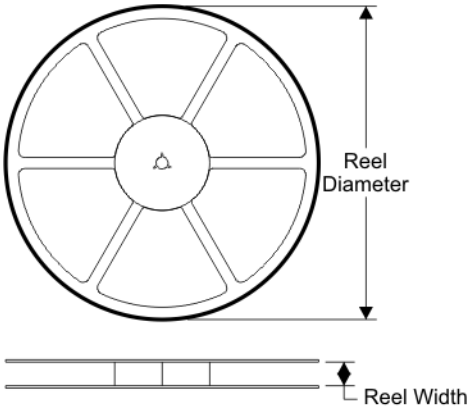
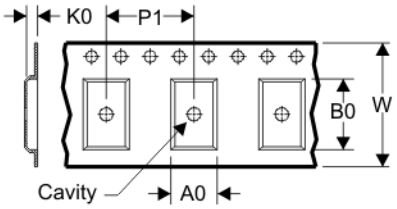
TAPE AND REEL BOX INFORMATION

REEL DIMENSIONS

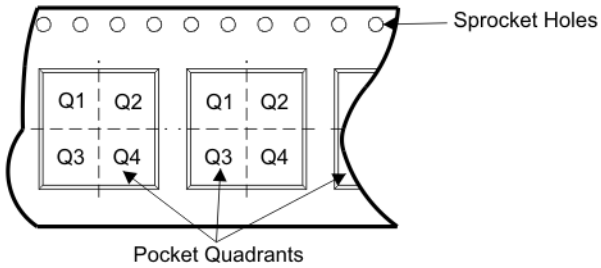


TAPE DIMENSIONS



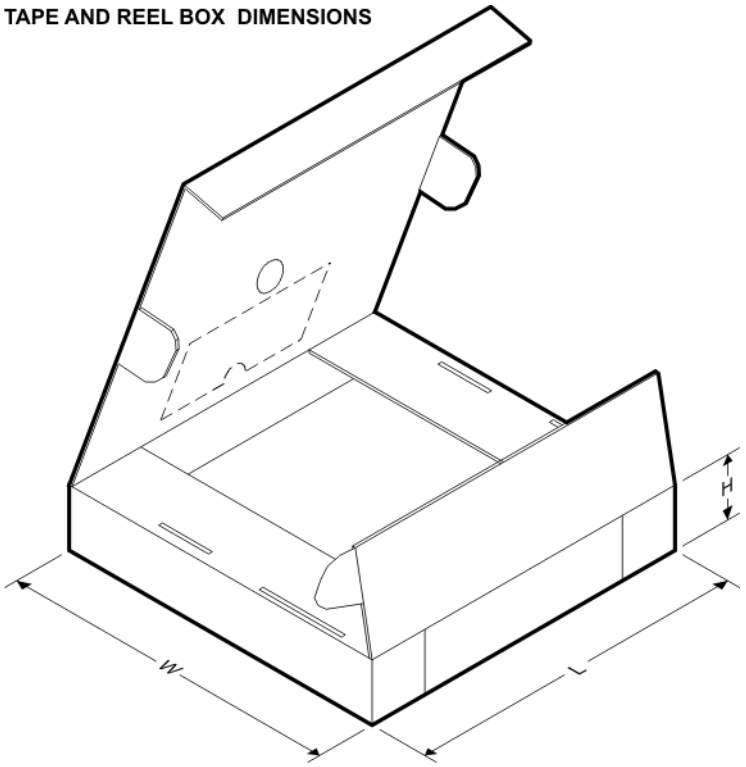
A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



Device	Package	Pins	Site	Reel Diameter (mm)	Reel Width (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS299DWR	DW	20	SITE 41	330	24	10.8	13.0	2.7	12	24	Q1

TAPE AND REEL BOX DIMENSIONS

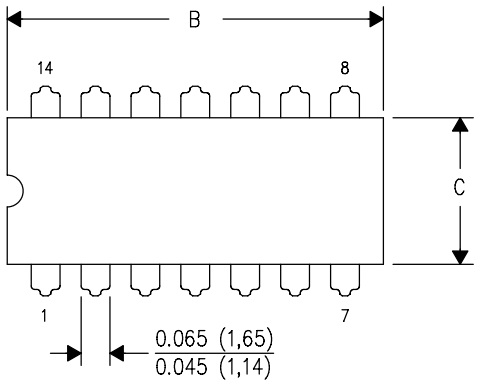


Device	Package	Pins	Site	Length (mm)	Width (mm)	Height (mm)
SN74LS299DWR	DW	20	SITE 41	346.0	346.0	41.0

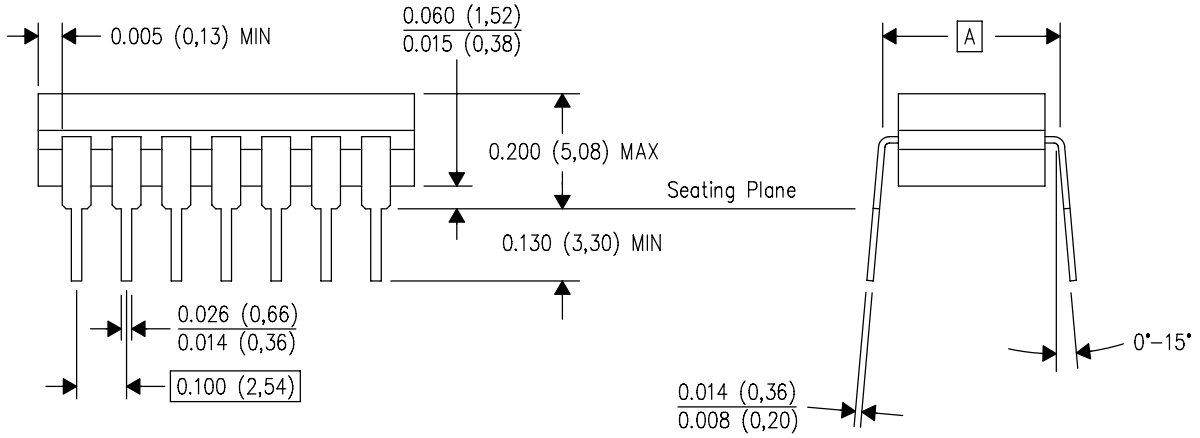
J (R–GDIP–T**)

14 LEADS SHOWN

CERAMIC DUAL IN–LINE PACKAGE



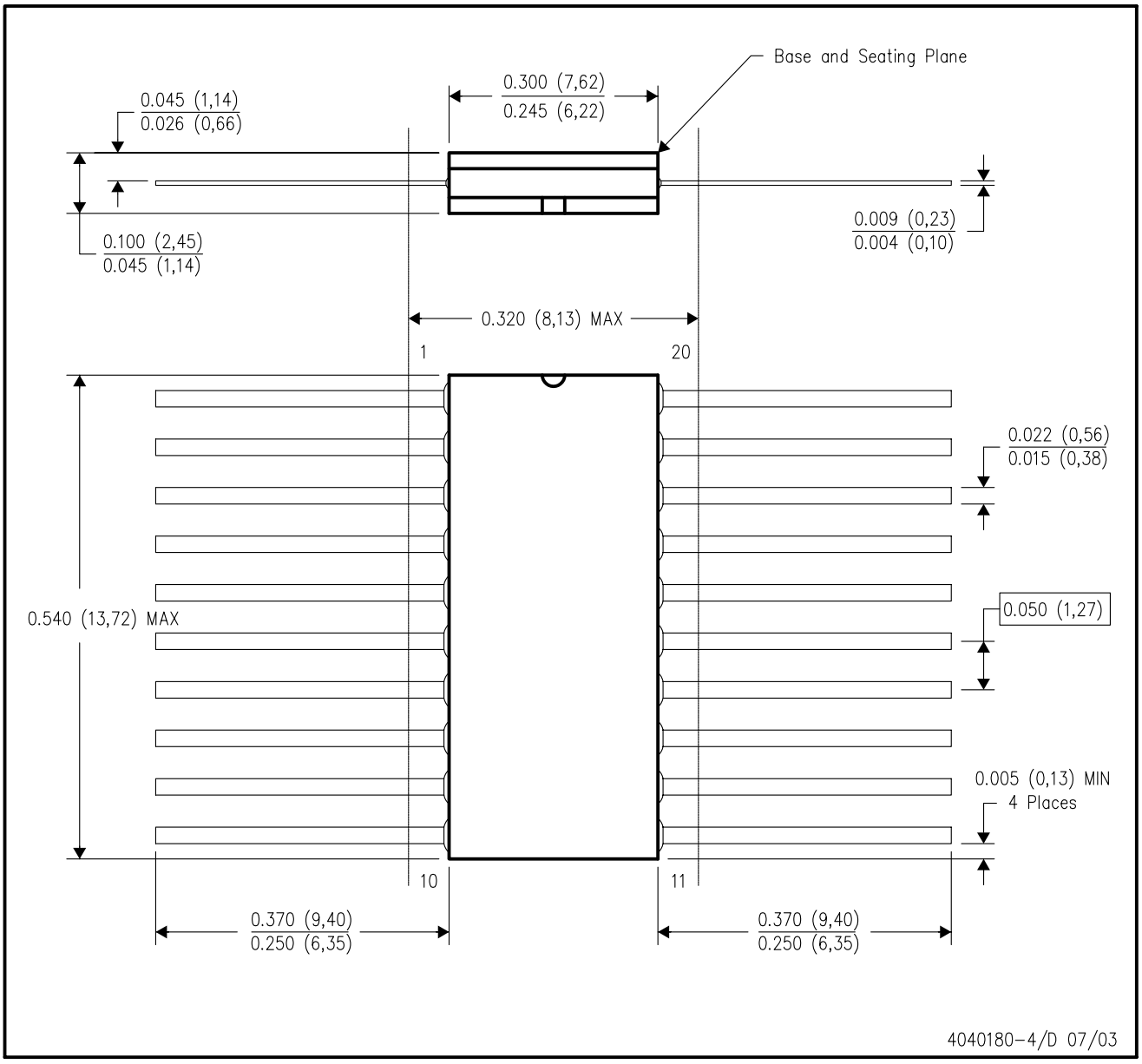
DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



4040083/F 03/03

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1–T14, GDIP1–T16, GDIP1–T18 and GDIP1–T20.

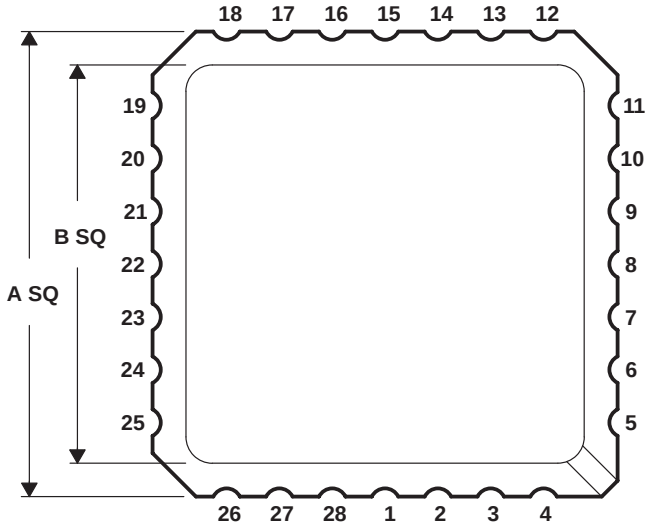
W (R–GDFP–F20) CERAMIC DUAL FLATPACK



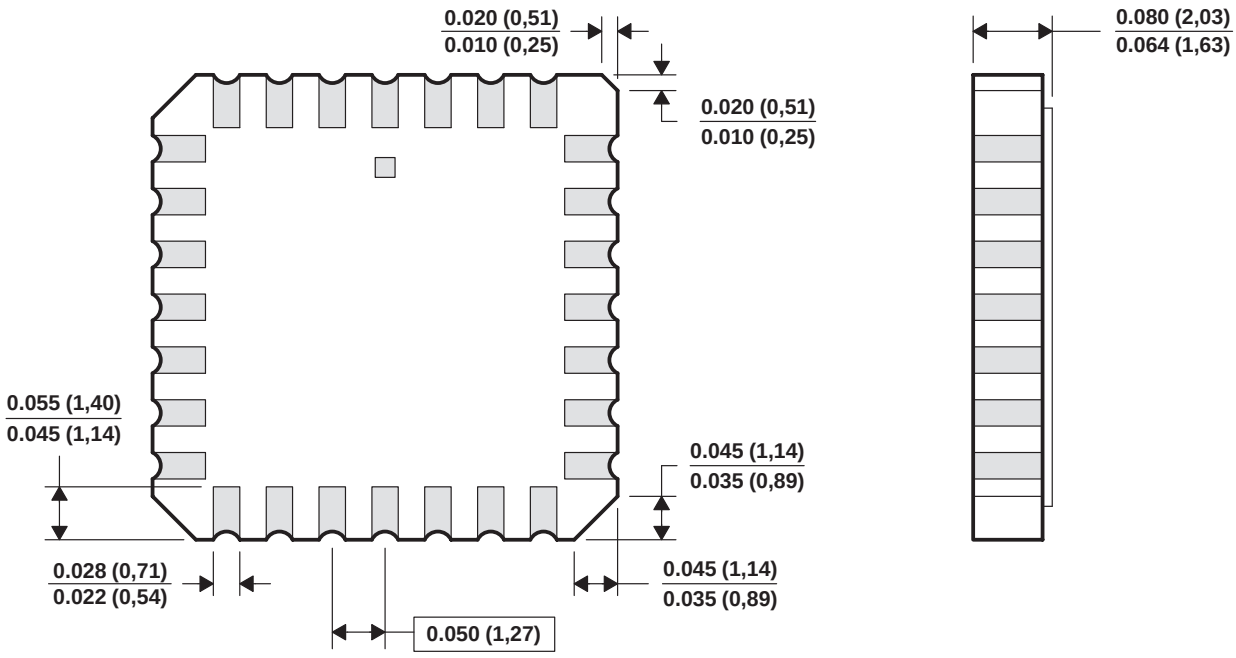
NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only.
E. Falls within Mil–Std 1835 GDFP2–F20

FK (S-CQCC-N)** **LEADLESS CERAMIC CHIP CARRIER**

28 TERMINAL SHOWN



NO. OF TERMINALS **	A		B	
	MIN	MAX	MIN	MAX
20	0.342 (8,69)	0.358 (9,09)	0.307 (7,80)	0.358 (9,09)
28	0.442 (11,23)	0.458 (11,63)	0.406 (10,31)	0.458 (11,63)
44	0.640 (16,26)	0.660 (16,76)	0.495 (12,58)	0.560 (14,22)
52	0.739 (18,78)	0.761 (19,32)	0.495 (12,58)	0.560 (14,22)
68	0.938 (23,83)	0.962 (24,43)	0.850 (21,6)	0.858 (21,8)
84	1.141 (28,99)	1.165 (29,59)	1.047 (26,6)	1.063 (27,0)



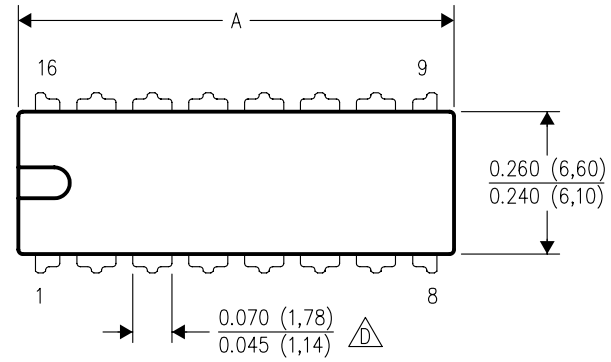
4040140/D 10/96

NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a metal lid.
D. The terminals are gold plated.
E. Falls within JEDEC MS-004

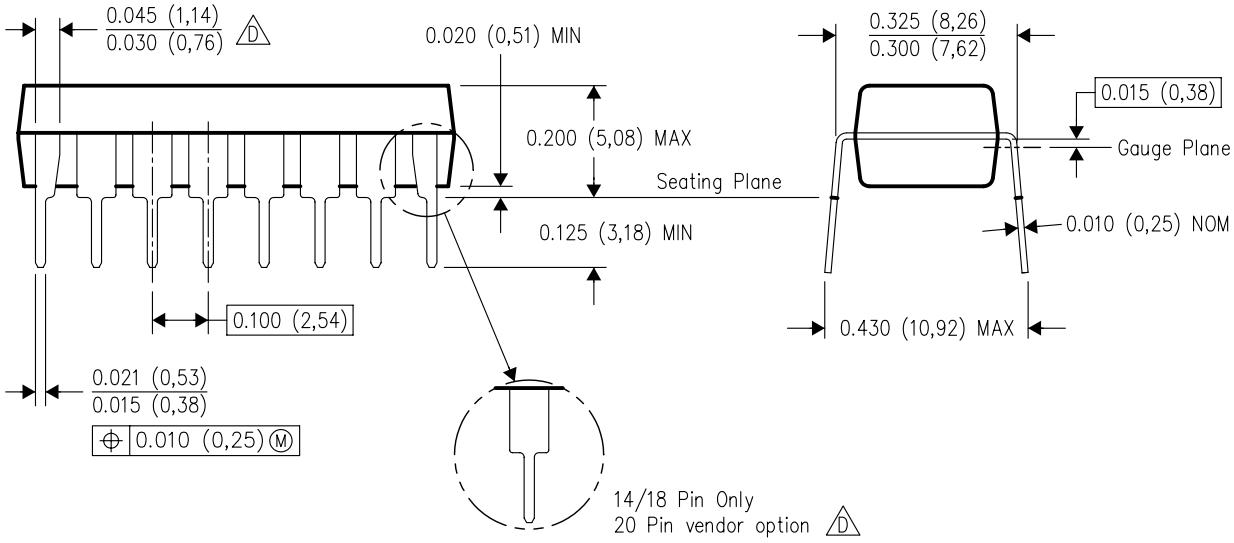
N (R–PDIP–T**)

PLASTIC DUAL–IN–LINE PACKAGE

16 PINS SHOWN



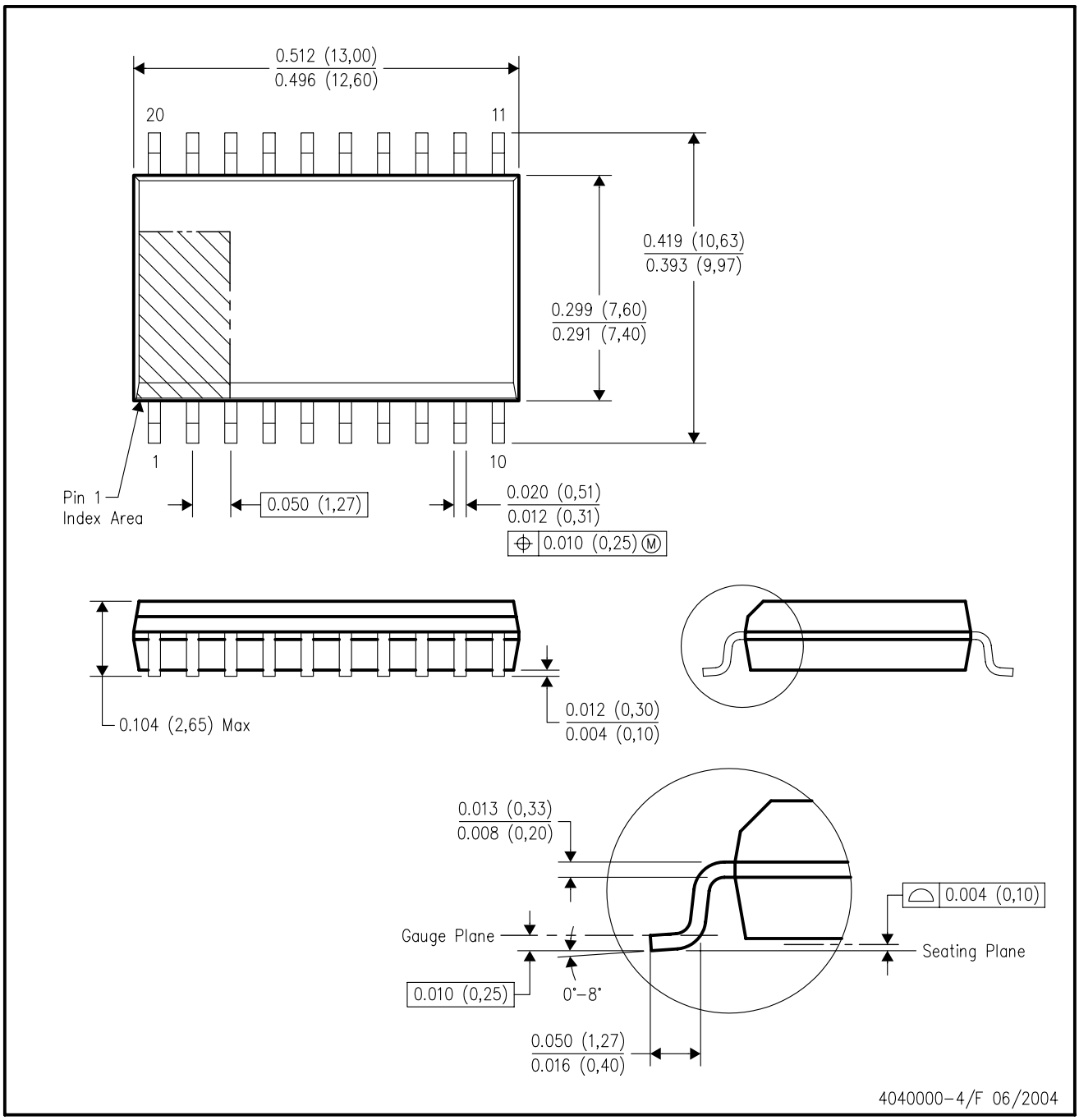
DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS–001 VARIATION (C)	AA	BB	AC	AD



4040049/E 12/2002

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS–001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

DW (R–PDSO–G20) PLASTIC SMALL–OUTLINE PACKAGE



NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
D. Falls within JEDEC MS–013 variation AC.

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